DISCLAIMER

This presentation has been prepared by Samsung Electronics Co., Ltd. (the "Company"). It does not purport to contain all the information that a prospective investor may require in connection with any potential investment in the Company. You should not treat the contents of this presentation, or any information provided in connection with it, as financial advice, financial product advice or advice relating to legal, taxation or investment matters.

No representation or warranty (whether express or implied) is made by the Company or any of its officers, advisers, agents or employees as to the accuracy, completeness or reasonableness of the information, statements, opinions or matters (express or implied) arising out of, contained in or derived from this presentation or provided in connection with it, or any omission from this presentation, nor as to the attainability of any estimates, forecasts or projections set out in this presentation.

This presentation is provided expressly on the basis that you will carry out your own independent inquiries into the matters contained in the presentation and make your own independent decisions about the affairs, financial position or prospects of the Company. The Company reserves the right to update, amend or supplement the information at any time in its absolute discretion (without incurring any obligation to do so).

Neither the Company, nor its related bodies corporate, officers, their advisers, agents and employees accept any responsibility or liability to you or to any other person or entity arising out of this presentation including pursuant to the general law (whether for negligence, under statute or otherwise). Any such responsibility or liability is, to the maximum extent permitted by law, expressly disclaimed and excluded. Nothing in this material should be construed as either an offer to sell or a solicitation of an offer to buy or sell securities. It does not include all available information and should not be used in isolation as a basis to invest in the Company.

Future Matters

This presentation contains reference to certain intentions, expectations, future plans, strategy and prospects of the Company. Those intentions, expectations, future plans, strategy and prospects may or may not be achieved. They are based on certain assumptions, which may not be met or on which views may differ and may be affected by known and unknown risks. The performance and operations of the Company may be influenced by a number of factors, many of which are outside the control of the Company. No representation or warranty, express or implied, is made by the Company, or any of its directors, officers, employees, advisers or agents that any intentions, expectations or plans will be achieved either totally or partially or that any particular rate of return will be achieved. Given the risks and uncertainties may cause the Company's actual future results, performance or achievements to be materially different from those expected, planned or intended, recipients should not place undue reliance on these intentions, expectations, future plans, strategy and prospects. The Company does not warrant or represent that the actual results, performance or achievements will be as expected, planned or intended.

US Disclosure

This document does not constitute any part of any offer to sell, or the solicitation of any offer to buy, any securities in the United States or to, or for the account or benefit of any "US person" as defined in Regulation S under the US Securities Act of 1993 ("Securities Act"). The Company's shares have not been, and will not be, registered under the Securities Act or the securities laws of any state or other jurisdiction of the United States, and may not be offered or sold in the United States or to any US person without being so registered or pursuant to an exemption from registration including an exemption for qualified institutional buyers.

SAMSUNG MEMORY

Investor Presentation

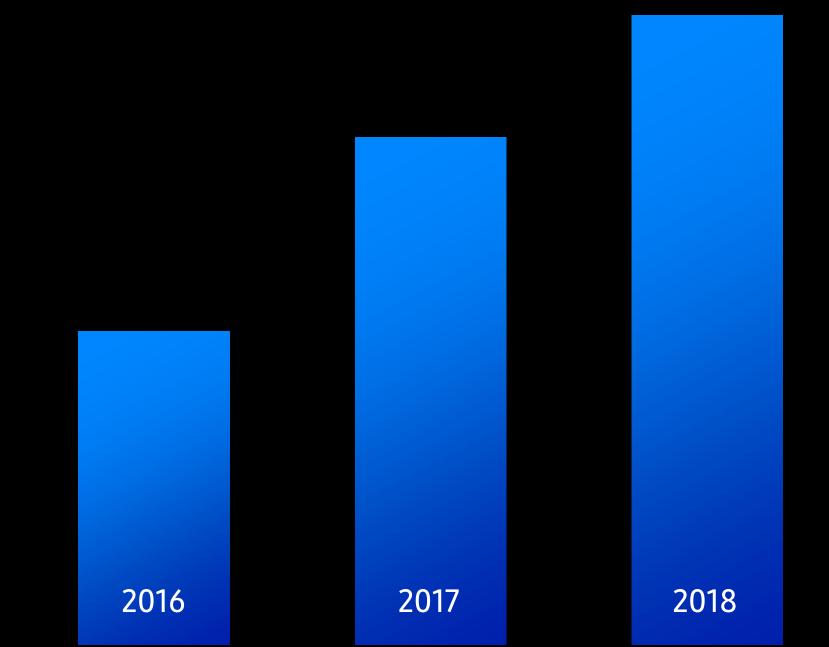
2023

CONTENTS

BUSINESS UPDATE MEMORY MARKET OPPORTUNITIES SAMSUNG STRATEGY

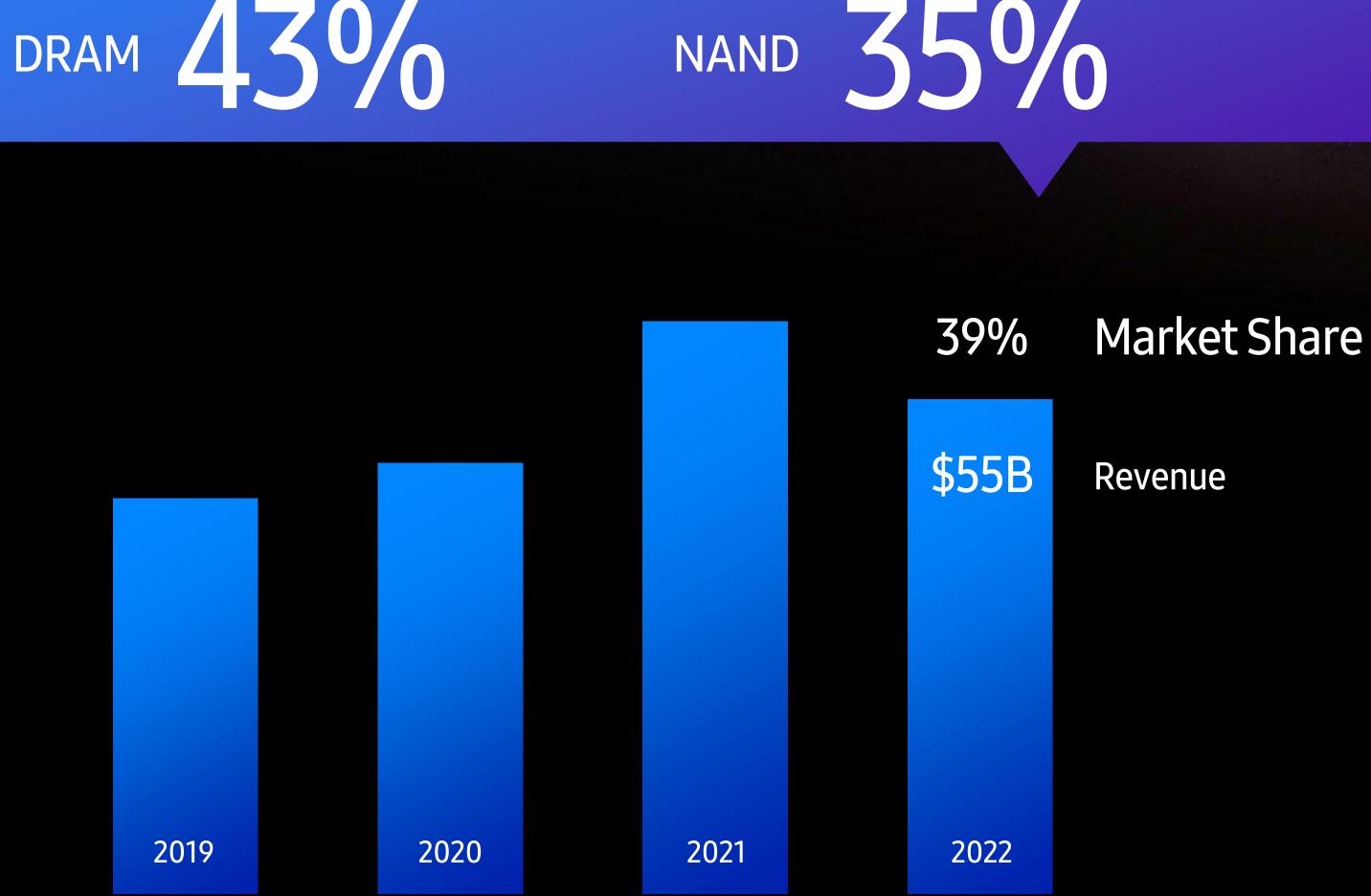
#1 in Memory Worldwide Since 1993, Well Balanced DRAM/NAND Portfolio

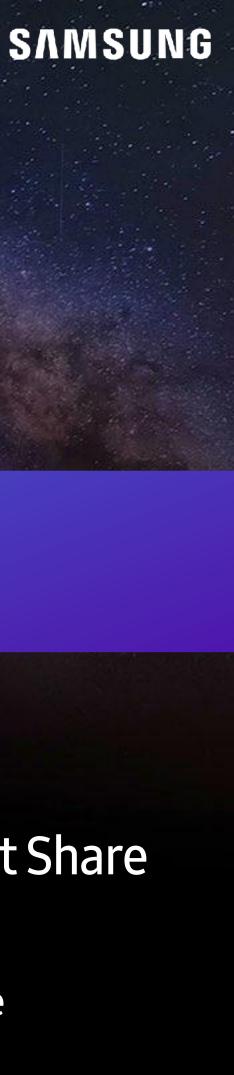
2022 Market Share

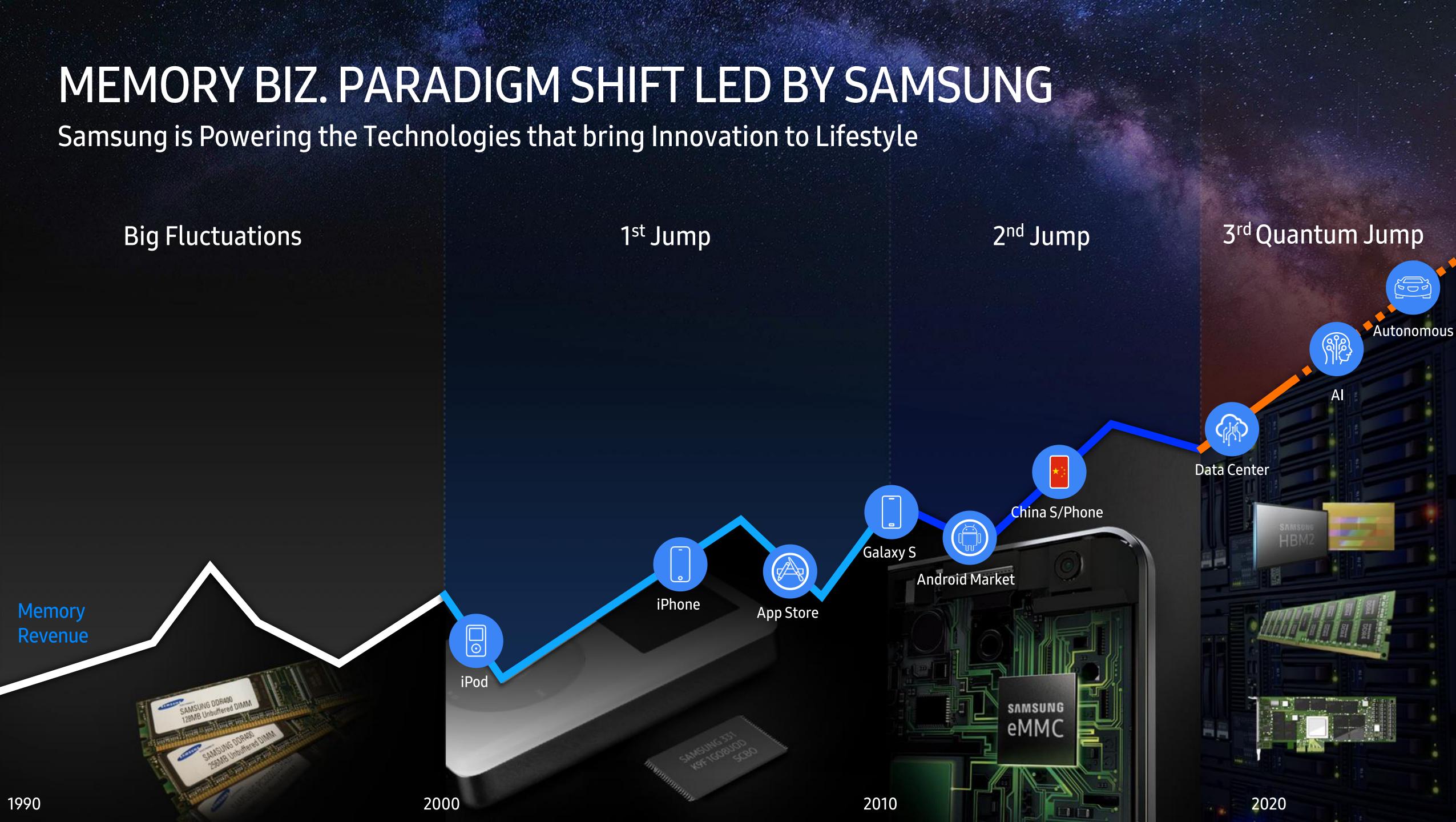


Source: IDC , Mar. '23







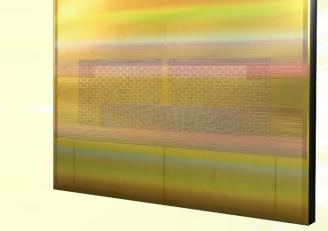


Beyond The Boundary

HUMAN

SAMSUNG HBM3 Icebolt





Samsung Memory



CONTENTS

BUSINESS UPDATE MEMORY MARKET OPPORTUNITIES SAMSUNG STRATEGY

SPREAD-OUT OF PUBLIC CLOUD Explosive Growth of Data



2nd WAVE



Cloud Service Providers



.Com & Forbes Top100



3rd WAVE

THE FLOOD OF DATA 4TH WAVE

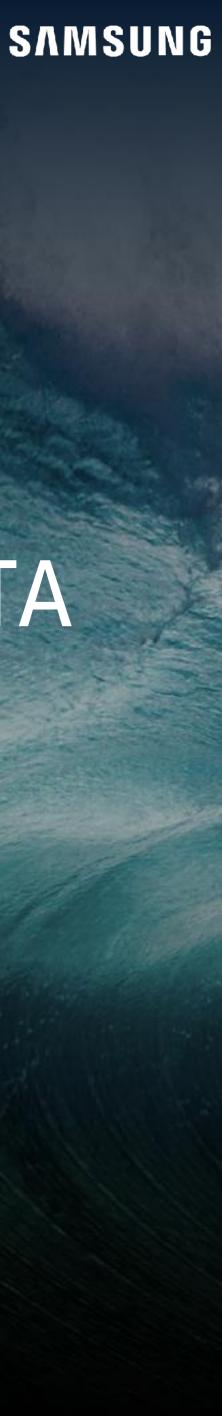
Telcos



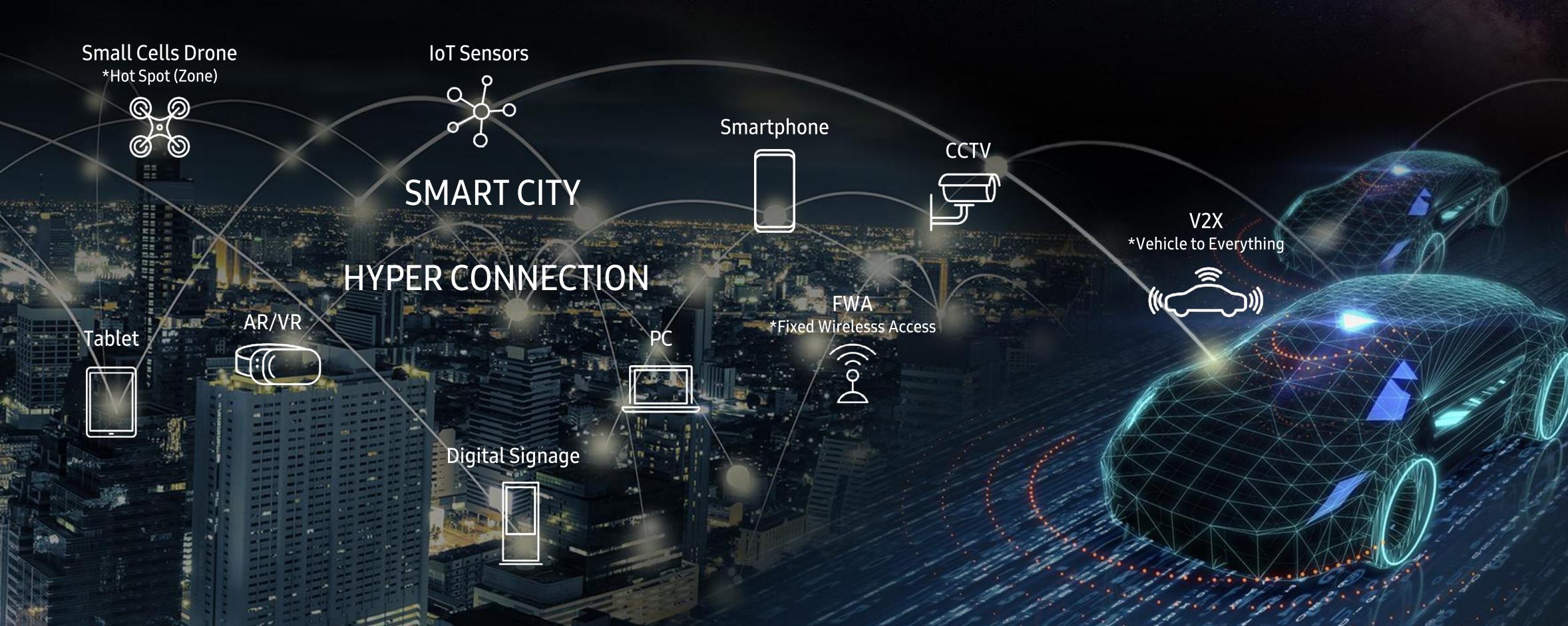
AI



Automotive

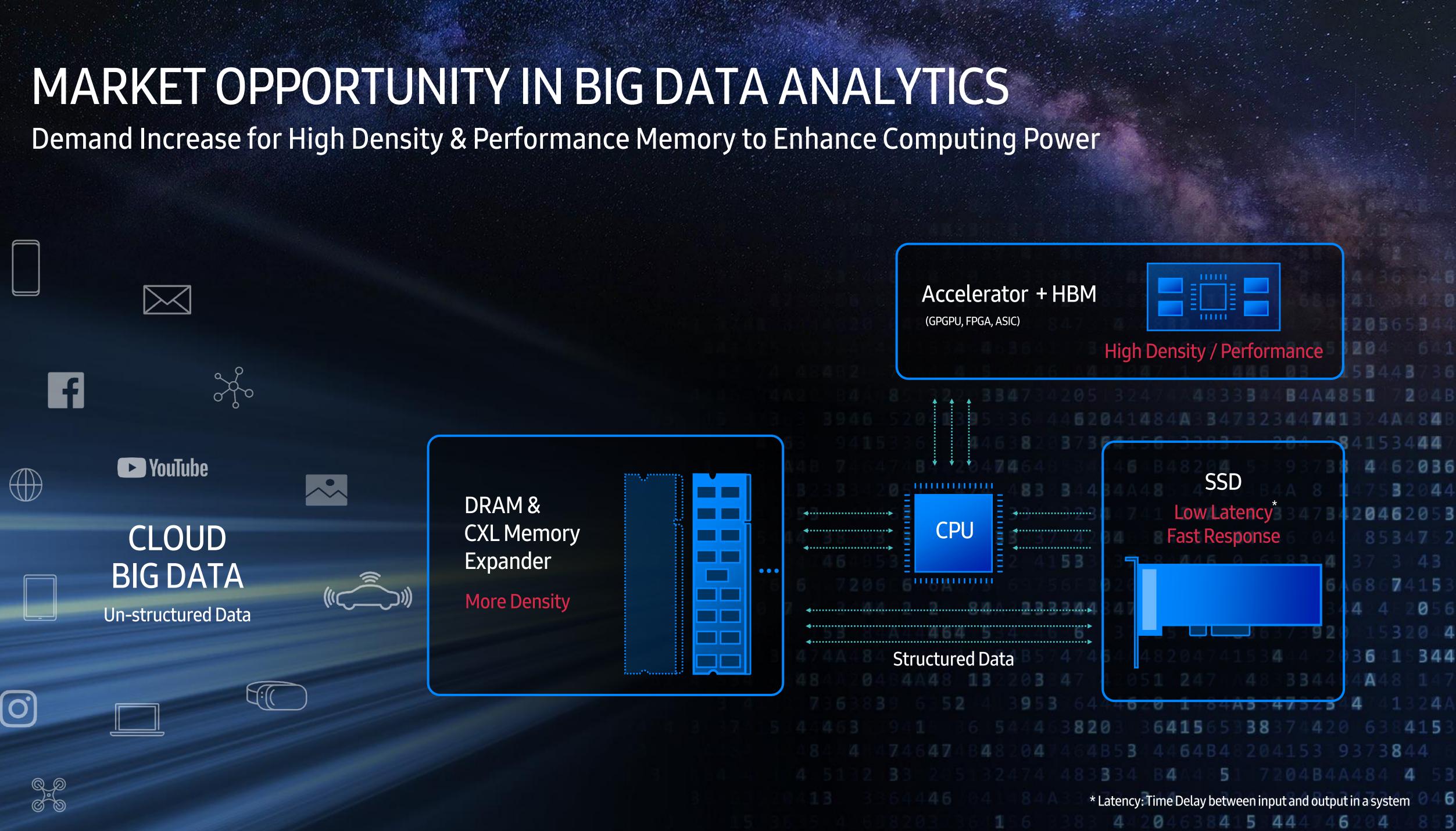


SMART CITY & AUTONOMOUS CAR FUELED BY 5G NETWORK Huge Amounts of Data Generated by Hyper-connected Devices



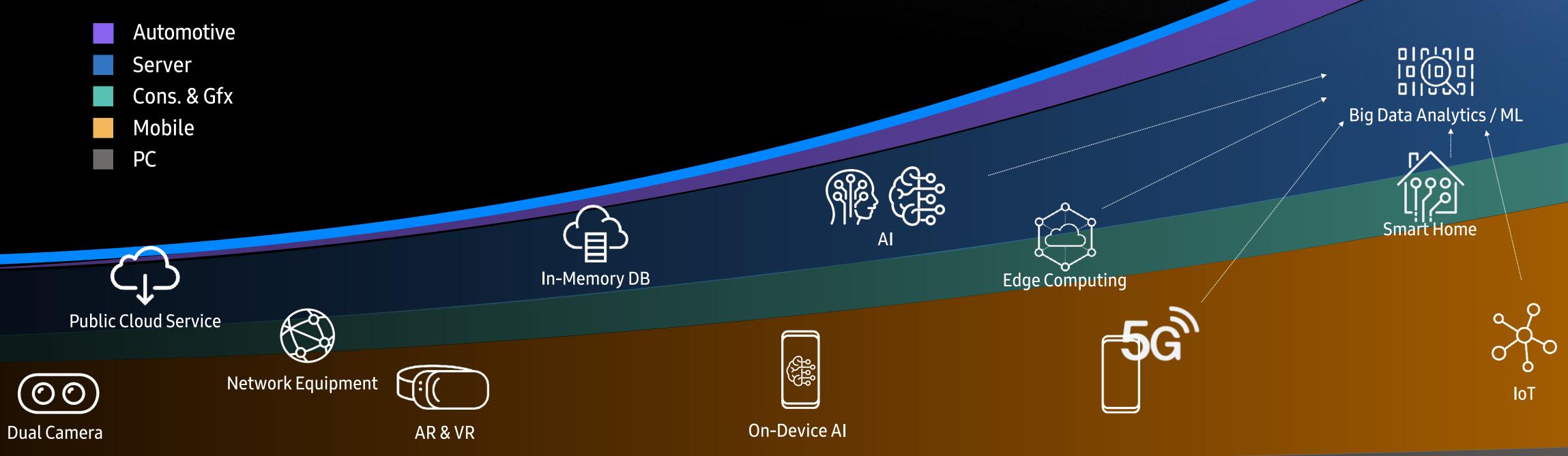


MARKET OPPORTUNITY IN BIG DATA ANALYTICS





CONTINUOUS GROWTH OF MEMORY DEMAND Memory Growth led by Server & Mobile devices based on Big Data Ecosystem







CONTENTS

BUSINESS UPDATE MEMORY MARKET OPPORTUNITIES SAMSUNG STRATEGY

SAMSUNG STRATEGY

Break-through Technology

TECH LEADERSHIP

S/W & CONTROLLERS

Enhanced Solutions

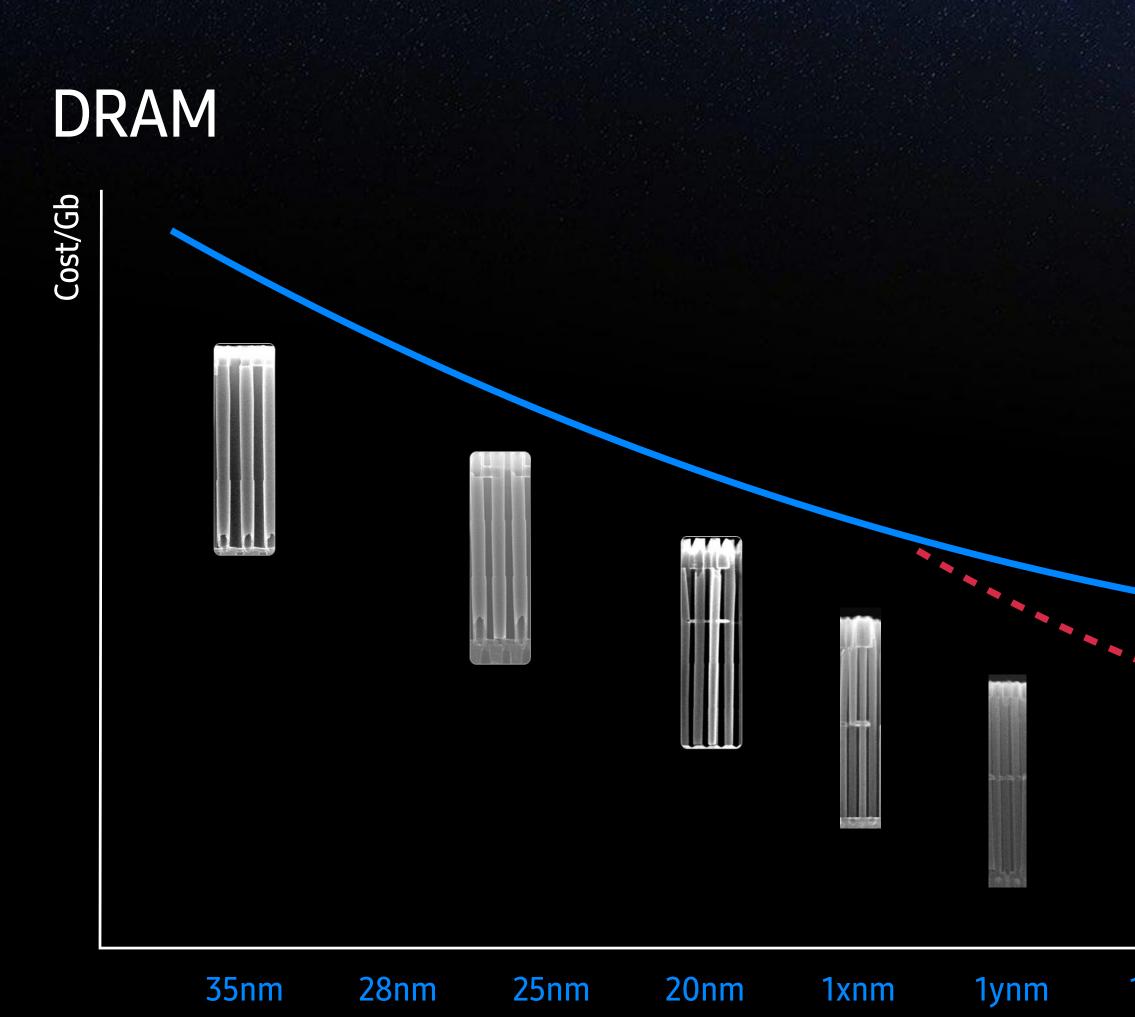
Advanced Manufacturing

EFFICIENCY & FLEXIBILITY



Break-through Technology

CONTINUOUS TECHNOLOGY SCALING Thru Technology Evolution

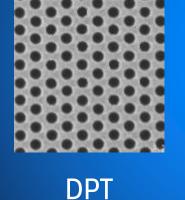


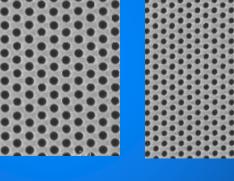
Source: Samsung

BEYOND <10nm

1znm 1anm 1bnm ···

FUTURE DRAM TECHNOLOGY



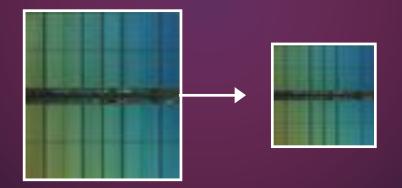


QPT

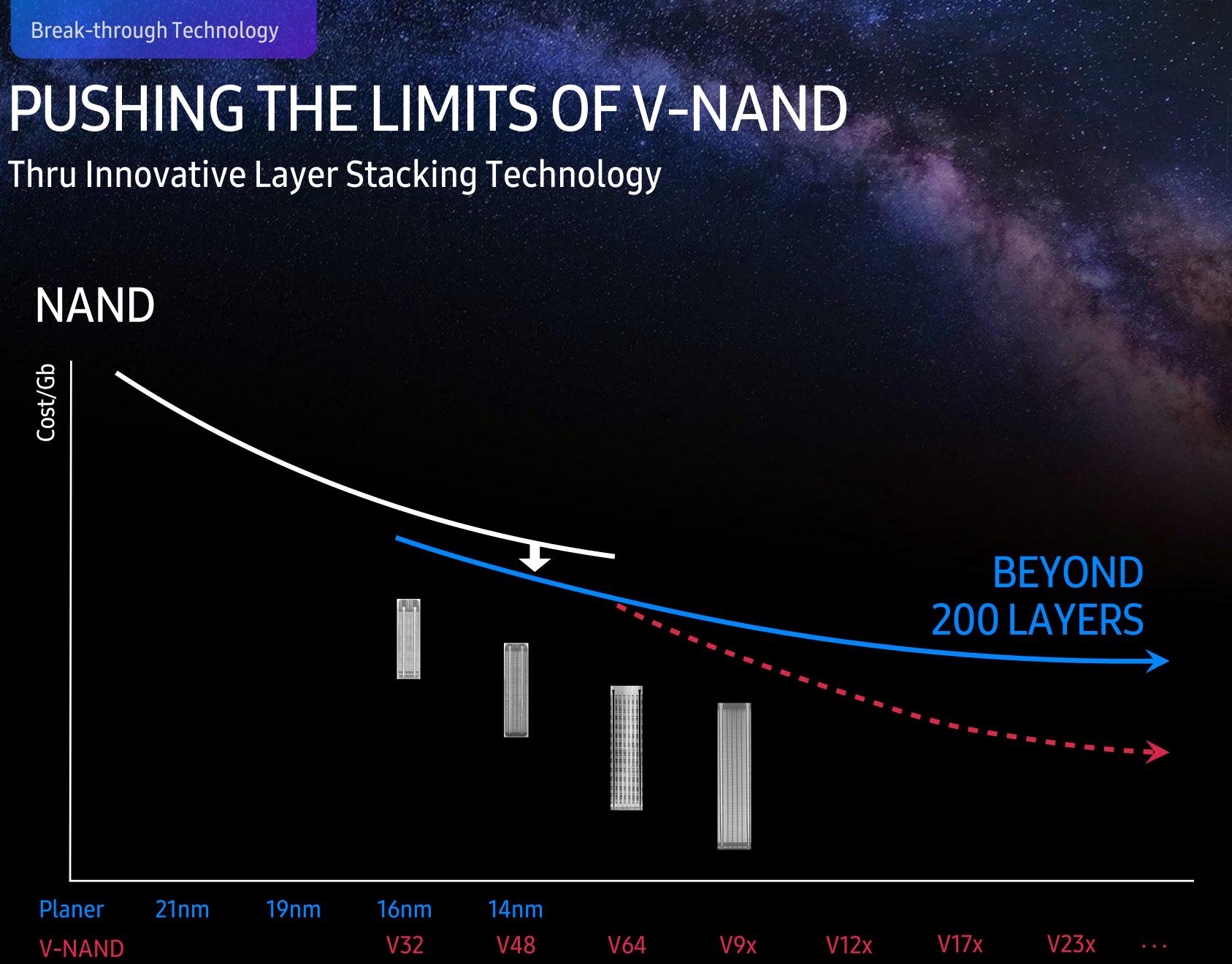
EUV

*DPT : Double Patterning Technology *QPT : Quadruple Patterning Technology *EUV : Extreme Ultra Violet

ADVANDCED DESIGN TECH







FUTURE V-NAND TECHNOLOGY



Vertical Stack-up

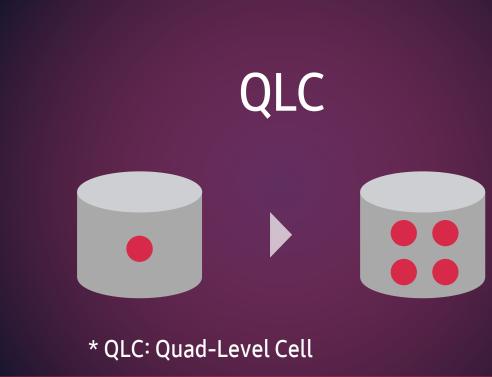
Multi-Stacking



Lateral Shrink



Cell Over Peri





Enhanced Solutions

UNIQUE CAPABILITIES FOR DIFFERENTIATED SOLUTIONS Integrating Key Components to Deliver Value-added Solutions

ADVANCED PROCESS TECHNOLOGY

Wafer / Chip







Higher Density



Less Power Consumption



Faster





ADVANCED PACKAGING TECHNOLOGY

Stacking / TSV

VERTICAL INTEGRATION

Software & Logic (Controller)

Thinner

Smaller

No Performance Loss



SHMSUNG

Customized



Expandable



Smarter



Secure



Enhanced Solutions

SAMSUNG SOLUTIONS FOR THE 5G ERA Enhanced Processing for Massive Data with Lower Latency & Less Power Consumption

FASTER DATA RATES WITH LOW POWER

3DS RDIMM, Z-SSD

Low Latency

High Capacity

Stable QoS

* Latency: Time Delay between input and output in a system



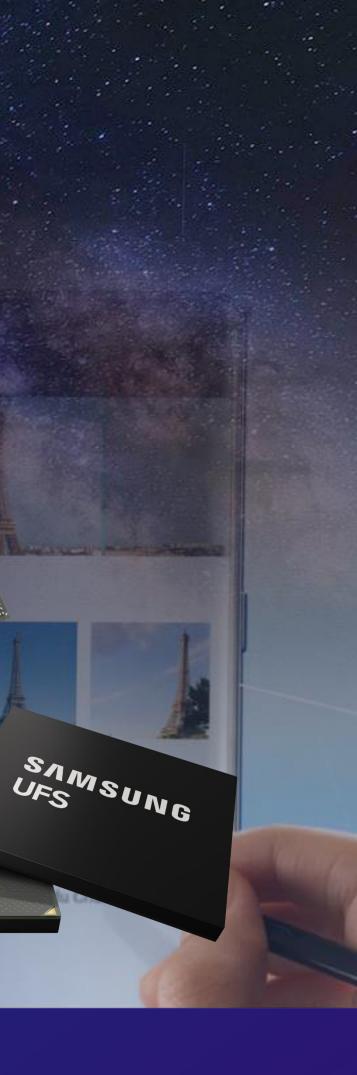
LPDDR5/5X

3-892-70-12-39

Higher Speed

Lower Power Consumption

Smaller Package





24GB HBM3 *

Fastest Performance

Energy Efficiency

* HBM: High Bandwidth Memory

32TB SAS SSD, 16TB NVMe SSD

Largest Density

Higher Reliability

Unparalleled Performance

Enhanced Solutions

SAMSUNG SOLUTIONS FOR AUTOMOTIVE INDUSTRY Advanced Total Memory Solution for Autonomous Driving Technology



Automotive Storage

High Density

High Performance

High Reliability

Dedicated Support for automotive

- Full Memory Line-ups
- Quality & Longevity
- Full In-house Solution

 \mathbf{O}

CONNECTED AUTONOMOUS

SAMSUNG LPDDR4X

Automotive DRAM

SAMSUNG

LPDDR5

High Bandwidth

Lower Power Consumption

Higher Reliability



Advanced Manufacturing

APPLICATION-ORIENTED LINE MANAGEMENT 2-Track Strategy for Efficient Production & Capacity Allocation

HIGH PERFORMANCE COMPUTING

ARTIFICIA

INTEL

PERFORMANCE Leading Process Technology

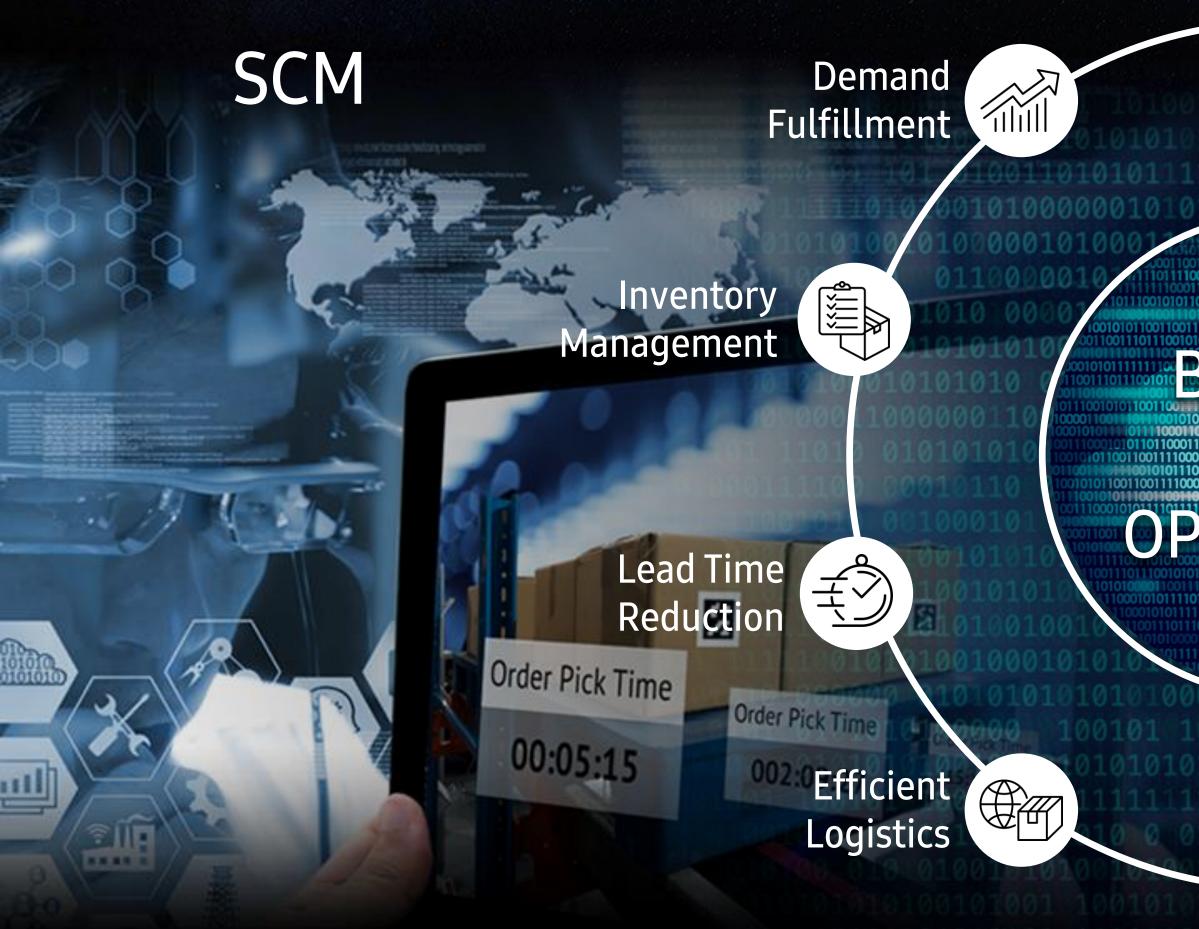
FLEXIBILITY DRAM/NAND Conversion

LONGEVITY Proven Process Technology



Advanced Manufacturing

EVOLUTION TO SMARTER FACTORY Customer Value Improvement through High Productivity and Enhanced SCM



* SCM: Supply Chain Management



Automated Operation

PRODUCTIVITY

I SU ETOCTT

Big Data Based OPERATION Seamless **Quality Control**

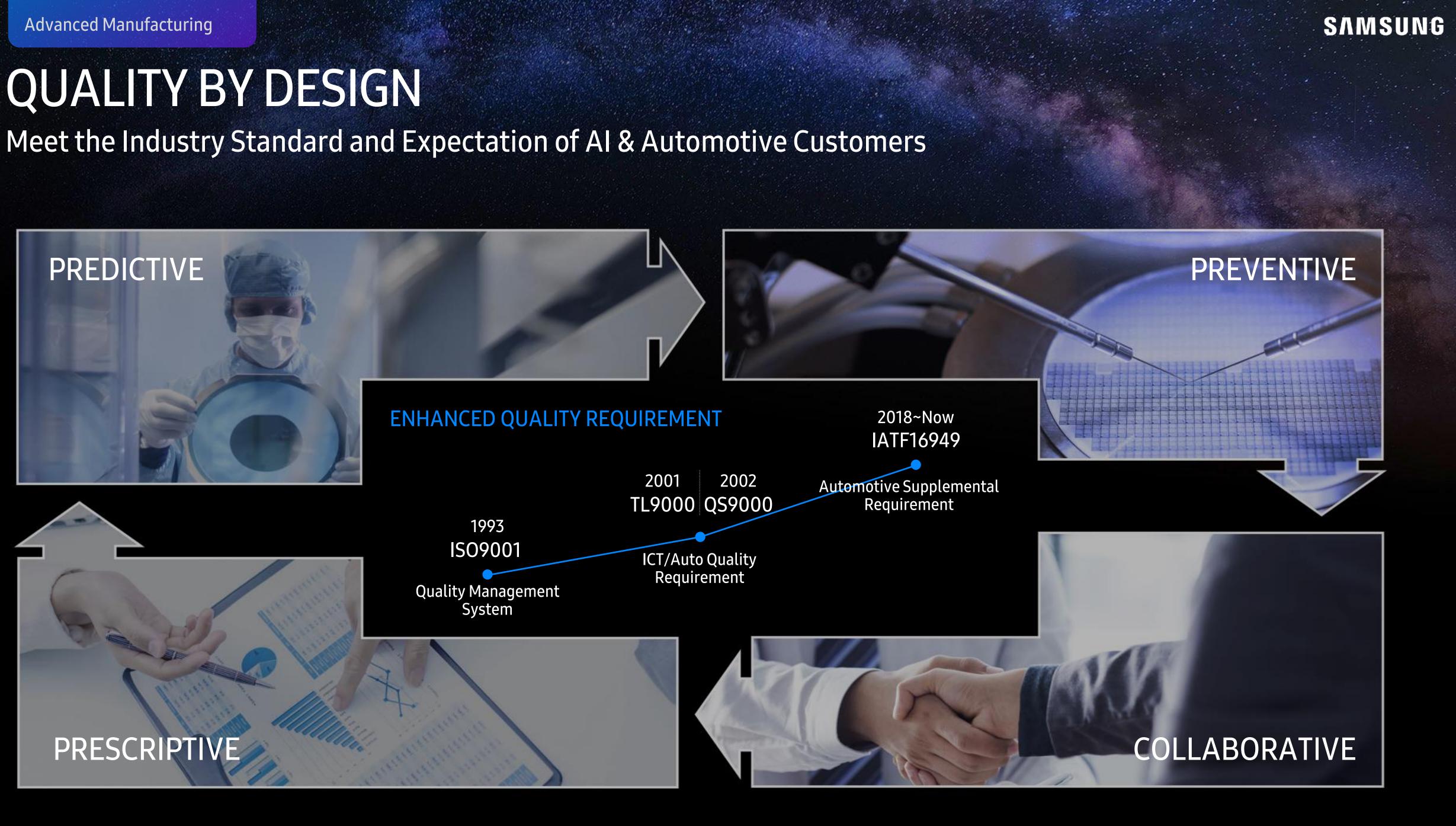
Intelligent میں میں میں Planning

Early Yield Improvement

日問題



QUALITY BY DESIGN





Placing Memory at the Forefront of Future Innovation and Creative IT Life

Technology

Leading Technological Breakthroughs

Customers

Supporting Customers' Future Innovation

Employees

Fostering Employees' Creativity

Society

Enriching a New Way of Digital Life

http://www.samsung.com/semiconductor

